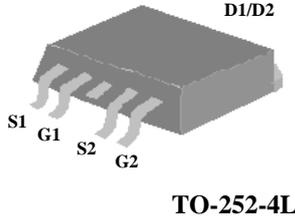




**Complementary N and P-channel
Enhancement-mode Power MOSFETs**

- Simple Drive Requirement
- Good Thermal Performance
- Fast Switching Performance
- RoHS-compliant, halogen-free

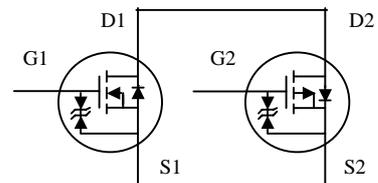


| | | |
|------|--------------|------|
| N-CH | BV_{DSS} | 40V |
| | $R_{DS(ON)}$ | 28mΩ |
| | I_D | 15A |
| P-CH | BV_{DSS} | -40V |
| | $R_{DS(ON)}$ | 42mΩ |
| | I_D | -12A |

Description

Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, low on-resistance and cost-effectiveness.

The AP4525GEH-HF-3 is in a four-lead TO-252 package, which is widely used for commercial and industrial surface-mount applications, and is well suited for applications such as DC and servo motor drives.



Absolute Maximum Ratings

| Symbol | Parameter | Rating | | Units |
|---------------------------------|---------------------------------------|------------|-----------|-------|
| | | N-channel | P-channel | |
| V_{DS} | Drain-Source Voltage | 40 | -40 | V |
| V_{GS} | Gate-Source Voltage | ±16 | ±16 | V |
| I_D at $T_A=25^\circ\text{C}$ | Continuous Drain Current ³ | 15.0 | -12.0 | A |
| I_D at $T_A=70^\circ\text{C}$ | Continuous Drain Current ³ | 12.0 | -10.0 | A |
| I_{DM} | Pulsed Drain Current ¹ | 50 | -50 | A |
| P_D at $T_A=25^\circ\text{C}$ | Total Power Dissipation | 10.4 | | W |
| | Linear Derating Factor | 0.083 | | W/°C |
| T_{STG} | Storage Temperature Range | -55 to 150 | | °C |
| T_J | Operating Junction Temperature Range | -55 to 150 | | °C |

Thermal Data

| Symbol | Parameter | Value | Unit |
|--------|---|-------|------|
| Rthj-c | Maximum Thermal Resistance, Junction-case | 12 | °C/W |
| Rthj-a | Maximum Thermal Resistance, Junction-ambient ³ | 40 | °C/W |

Ordering Information

AP4525GEH-HF-3TR RoHS-compliant TO-252-4L, shipped on tape and reel (3000 pcs/reel)
No longer recommended for new designs - use AP4543GEH-HF-3TR



N-channel Electrical Specifications at $T_j=25^\circ\text{C}$ (unless otherwise specified)

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units |
|------------------------------|---|--|------|------|----------|--------------------|
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS}=0V, I_D=250\mu A$ | 40 | - | - | V |
| $\Delta BV_{DSS}/\Delta T_j$ | Breakdown Voltage Temperature Coefficient | Reference to 25°C , $I_D=1\text{mA}$ | - | 0.03 | - | $V/^\circ\text{C}$ |
| $R_{DS(ON)}$ | Static Drain-Source On-Resistance ² | $V_{GS}=10V, I_D=6A$ | - | - | 28 | $\text{m}\Omega$ |
| | | $V_{GS}=4.5V, I_D=4A$ | - | - | 32 | $\text{m}\Omega$ |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS}=V_{GS}, I_D=250\mu A$ | 1 | - | 3 | V |
| g_{fs} | Forward Transconductance | $V_{DS}=10V, I_D=6A$ | - | 6 | - | S |
| I_{DSS} | Drain-Source Leakage Current | $V_{DS}=40V, V_{GS}=0V$ | - | - | 1 | μA |
| | Drain-Source Leakage Current ($T_j=70^\circ\text{C}$) | $V_{DS}=32V, V_{GS}=0V$ | - | - | 25 | μA |
| I_{GSS} | Gate-Source Leakage | $V_{GS}=\pm 16V$ | - | - | ± 30 | μA |
| Q_g | Total Gate Charge ² | $I_D=6A$ | - | 9 | 14 | nC |
| Q_{gs} | Gate-Source Charge | $V_{DS}=20V$ | - | 1.5 | - | nC |
| Q_{gd} | Gate-Drain ("Miller") Charge | $V_{GS}=4.5V$ | - | 4 | - | nC |
| $t_{d(on)}$ | Turn-on Delay Time ² | $V_{DS}=20V$ | - | 7 | - | ns |
| t_r | Rise Time | $I_D=6A$ | - | 20 | - | ns |
| $t_{d(off)}$ | Turn-off Delay Time | $R_G=3\Omega, V_{GS}=10V$ | - | 20 | - | ns |
| t_f | Fall Time | $R_D=3.3\Omega$ | - | 4 | - | ns |
| C_{iss} | Input Capacitance | $V_{GS}=0V$ | - | 580 | 930 | pF |
| C_{oss} | Output Capacitance | $V_{DS}=25V$ | - | 100 | - | pF |
| C_{riss} | Reverse Transfer Capacitance | $f=1.0\text{MHz}$ | - | 70 | - | pF |
| R_g | Gate Resistance | $f=1.0\text{MHz}$ | - | 2 | 3 | Ω |

Source-Drain Diode

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units |
|----------|------------------------------------|----------------------|------|------|------|-------|
| V_{SD} | Forward On Voltage ² | $I_S=15A, V_{GS}=0V$ | - | - | 1.8 | V |
| t_{rr} | Reverse Recovery Time ² | $I_S=6A, V_{GS}=0V$ | - | 20 | - | ns |
| Q_{rr} | Reverse Recovery Charge | $di/dt=100A/\mu s$ | - | 15 | - | nC |

Notes:

1. Pulse width limited by maximum junction temperature.
2. Pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
3. Values are the same for both N-CH and P-CH MOSFETs, when mounted on 2oz FR4 board, $t \leq 10s$.

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

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P-channel Electrical Specifications at $T_j=25^\circ\text{C}$ (unless otherwise specified)

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units |
|------------------------------|---|--|------|-------|----------|--------------------|
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS}=0V, I_D=-250\mu A$ | -40 | - | - | V |
| $\Delta BV_{DSS}/\Delta T_j$ | Breakdown Voltage Temperature Coefficient | Reference to $25^\circ\text{C}, I_D=-1\text{mA}$ | - | -0.03 | - | $V/^\circ\text{C}$ |
| $R_{DS(ON)}$ | Static Drain-Source On-Resistance ² | $V_{GS}=-10V, I_D=-5A$ | - | - | 42 | $\text{m}\Omega$ |
| | | $V_{GS}=-4.5V, I_D=-3A$ | - | - | 60 | $\text{m}\Omega$ |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS}=V_{GS}, I_D=-250\mu A$ | -0.8 | - | -2.5 | V |
| g_{fs} | Forward Transconductance | $V_{DS}=-10V, I_D=-5A$ | - | 5 | - | S |
| I_{DSS} | Drain-Source Leakage Current | $V_{DS}=-40V, V_{GS}=0V$ | - | - | -1 | μA |
| | Drain-Source Leakage Current ($T_j=70^\circ\text{C}$) | $V_{DS}=-32V, V_{GS}=0V$ | - | - | -25 | μA |
| I_{GSS} | Gate-Source Leakage | $V_{GS}=\pm 16V$ | - | - | ± 30 | μA |
| Q_g | Total Gate Charge ² | $I_D=-5A$ | - | 9 | 24 | nC |
| Q_{gs} | Gate-Source Charge | $V_{DS}=-20V$ | - | 2 | - | nC |
| Q_{gd} | Gate-Drain ("Miller") Charge | $V_{GS}=-4.5V$ | - | 5 | - | nC |
| $t_{d(on)}$ | Turn-on Delay Time ² | $V_{DS}=-20V$ | - | 8.5 | - | ns |
| t_r | Rise Time | $I_D=-5A$ | - | 15 | - | ns |
| $t_{d(off)}$ | Turn-off Delay Time | $R_G=3\Omega, V_{GS}=-10V$ | - | 27 | - | ns |
| t_f | Fall Time | $R_D=4\Omega$ | - | 25 | - | ns |
| C_{iss} | Input Capacitance | $V_{GS}=0V$ | - | 770 | 1230 | pF |
| C_{oss} | Output Capacitance | $V_{DS}=-20V$ | - | 165 | - | pF |
| C_{rss} | Reverse Transfer Capacitance | $f=1.0\text{MHz}$ | - | 115 | - | pF |
| R_g | Gate Resistance | $f=1.0\text{MHz}$ | - | 6 | 9 | Ω |

Source-Drain Diode

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units |
|----------|------------------------------------|-----------------------|------|------|------|-------|
| V_{SD} | Forward On Voltage ² | $I_S=-12A, V_{GS}=0V$ | - | - | -1.8 | V |
| t_{rr} | Reverse Recovery Time ² | $I_S=-5A, V_{GS}=0V$ | - | 20 | - | ns |
| Q_{rr} | Reverse Recovery Charge | $di/dt=-100A/\mu s$ | - | 16 | - | nC |

Notes:

1. Pulse width limited by maximum junction temperature.
2. Pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
3. Values are the same for both N-CH and P-CH MOSFETs, when mounted on 2oz FR4 board, $t \leq 10s$.

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Typical N-channel Electrical Characteristics

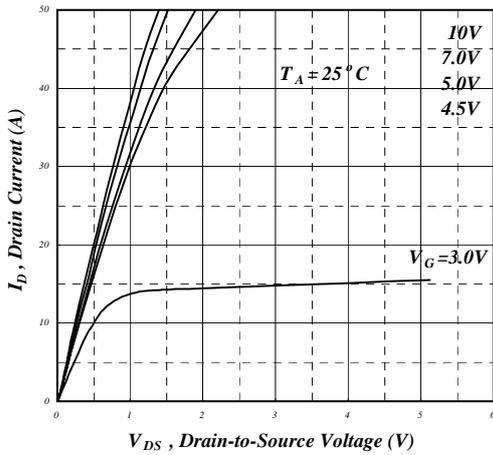


Fig 1. Typical Output Characteristics

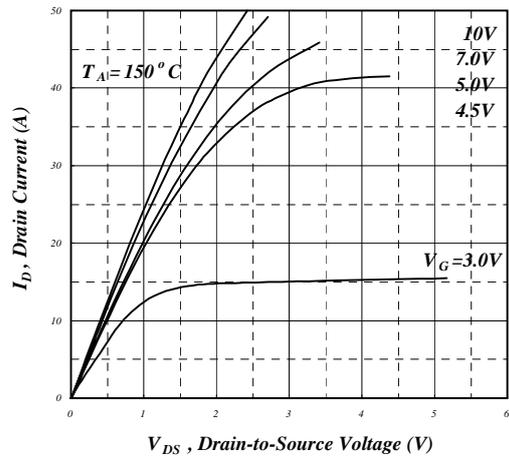


Fig 2. Typical Output Characteristics

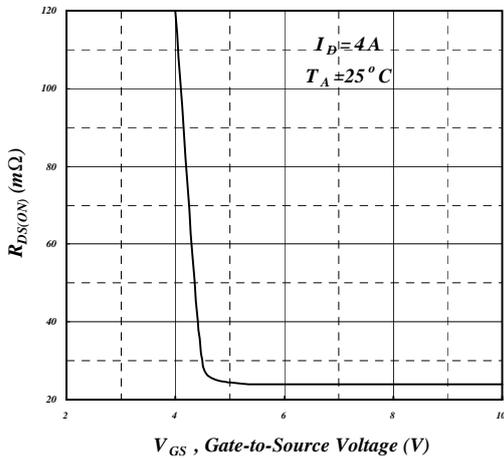


Fig 3. On-Resistance vs. Gate Voltage

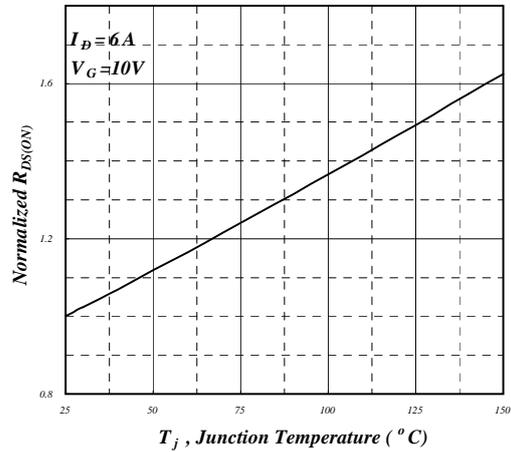


Fig 4. Normalized On-Resistance vs. Junction Temperature

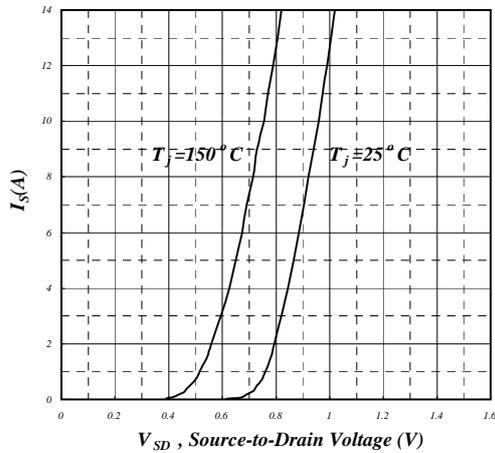


Fig 5. Forward Characteristic of Reverse Diode

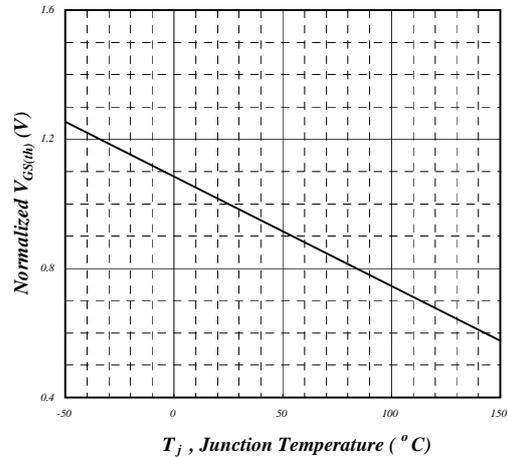


Fig 6. Gate Threshold Voltage vs. Junction Temperature



Typical N-channel Electrical Characteristics (cont.)

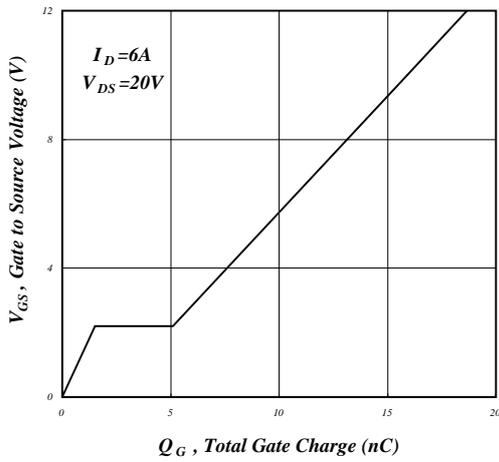


Fig 7. Gate Charge Characteristics

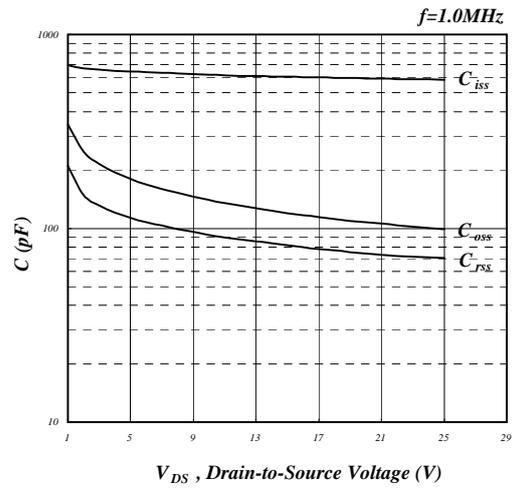


Fig 8. Typical Capacitance Characteristics

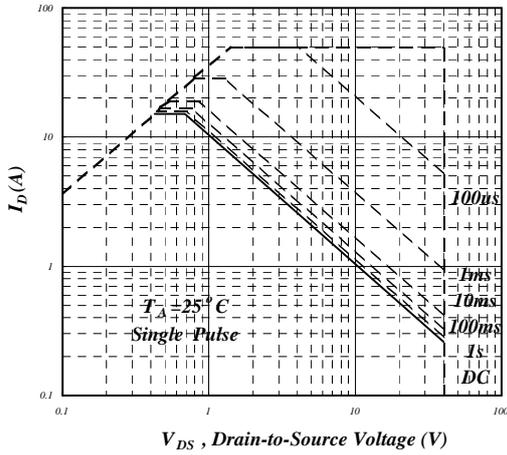


Fig 9. Maximum Safe Operating Area

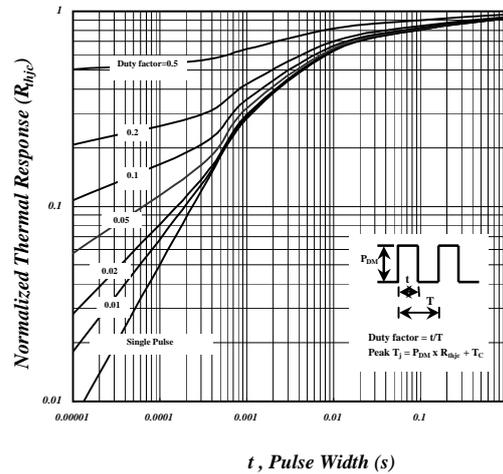


Fig 10. Effective Transient Thermal Impedance

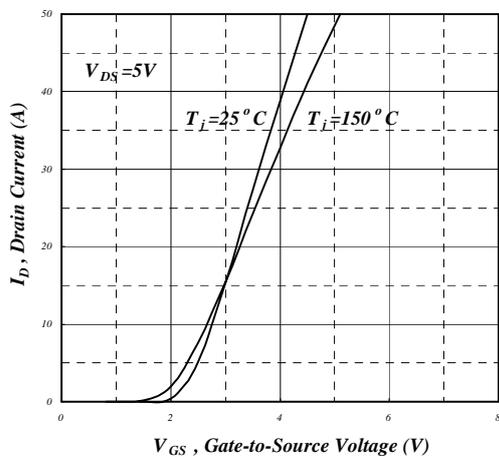


Fig 11. Transfer Characteristics

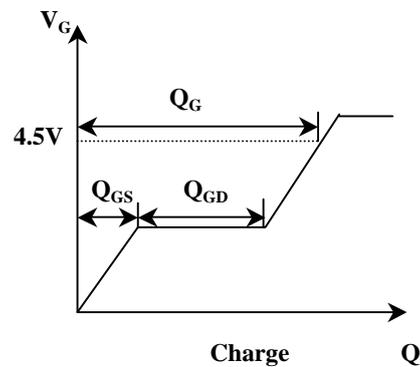


Fig 12. Gate Charge Waveform



Typical P-channel Electrical Characteristics

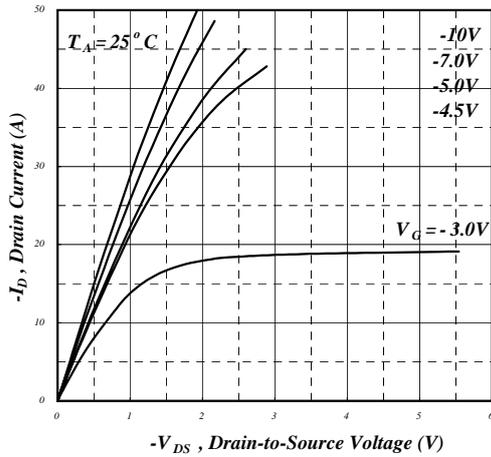


Fig 1. Typical Output Characteristics

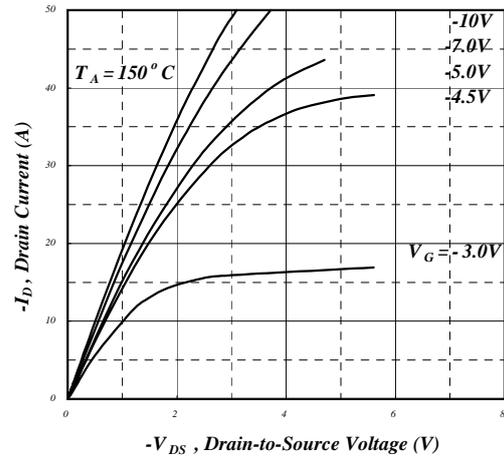


Fig 2. Typical Output Characteristics

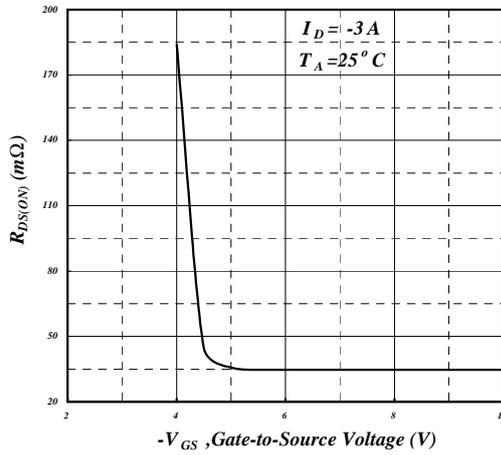


Fig 3. On-Resistance vs. Gate Voltage

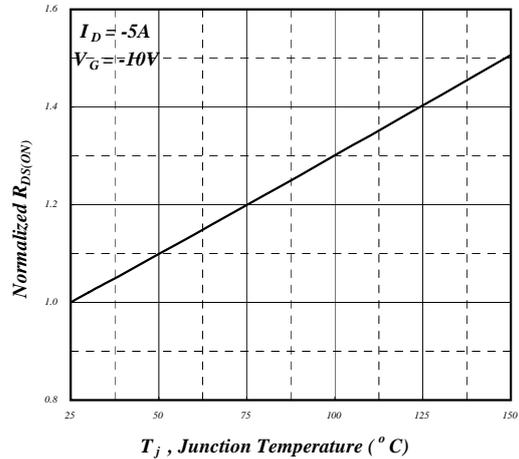


Fig 4. Normalized On-Resistance vs. Junction Temperature

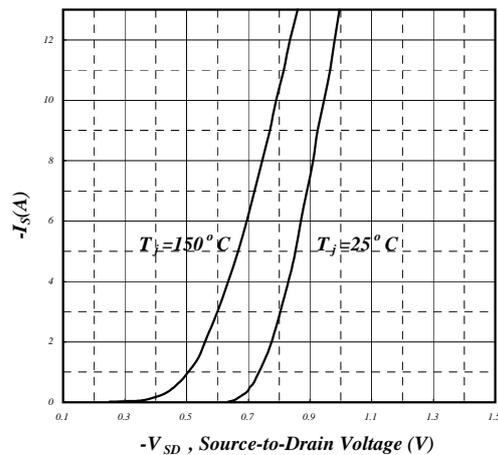


Fig 5. Forward Characteristic of Reverse Diode

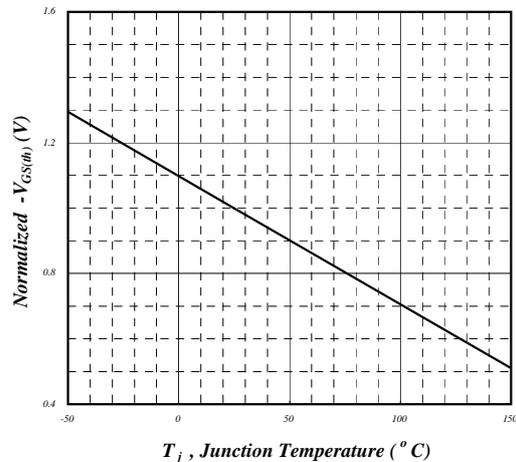


Fig 6. Gate Threshold Voltage vs. Junction Temperature



Typical P-channel Electrical Characteristics (cont.)

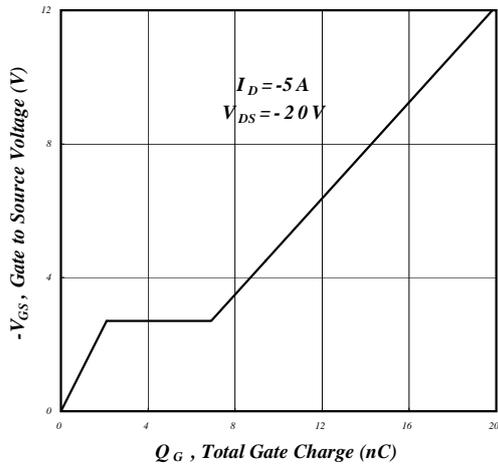


Fig 7. Gate Charge Characteristics

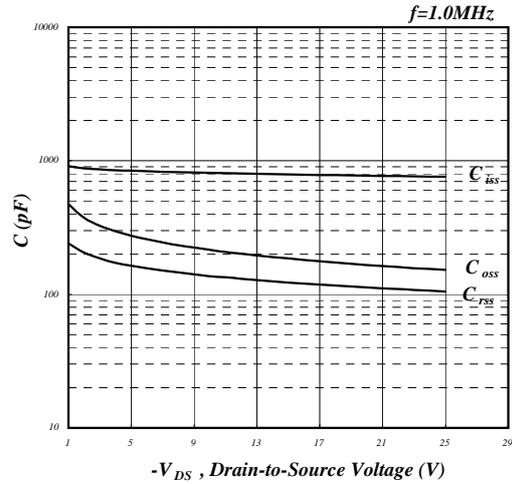


Fig 8. Typical Capacitance Characteristics

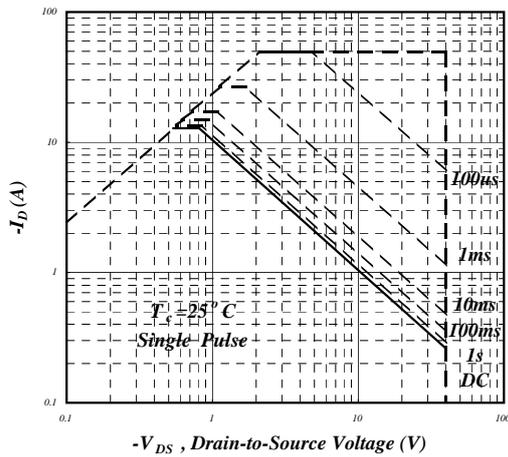


Fig 9. Maximum Safe Operating Area

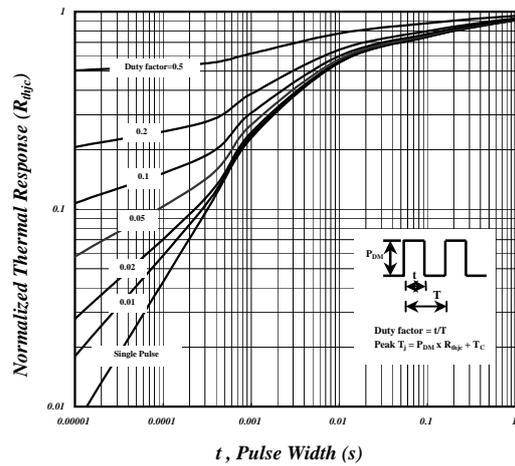


Fig 10. Effective Transient Thermal Impedance

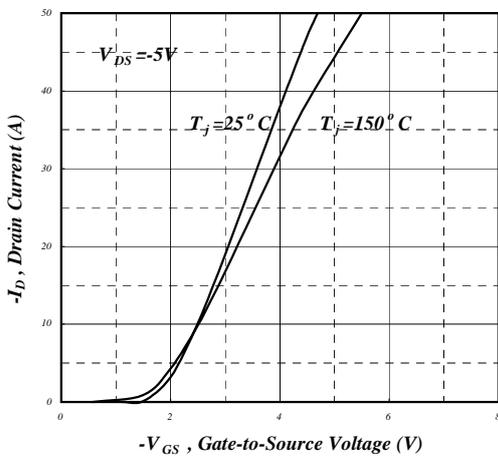


Fig 11. Transfer Characteristics

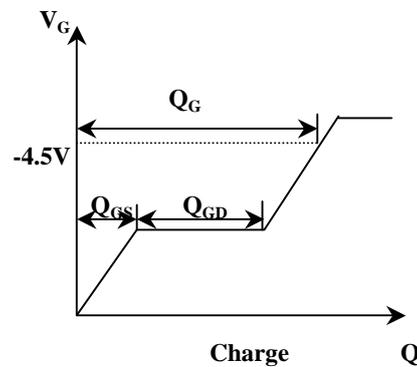
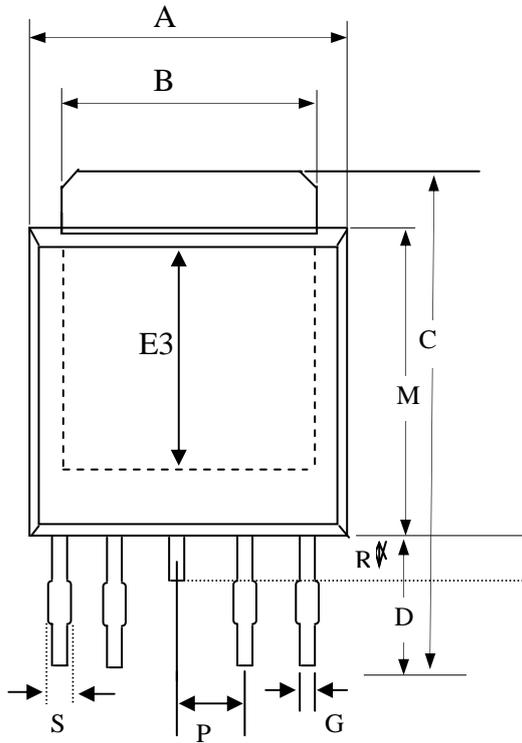


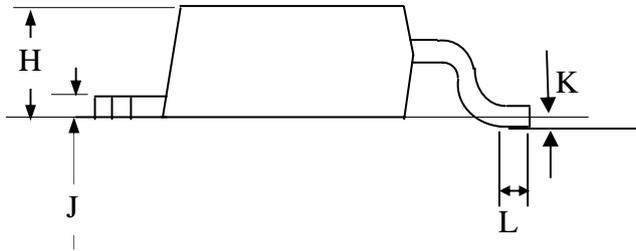
Fig 12. Gate Charge Waveform



Package Dimensions: TO-252-4L

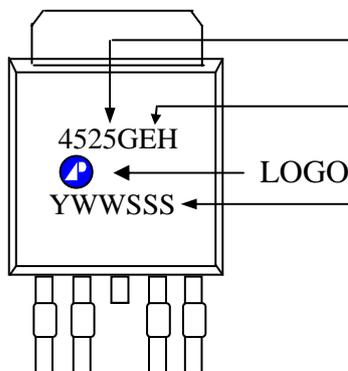


| SYMBOLS | Millimeters | | |
|---------|-------------|-------|-------|
| | MIN | NOM | MAX |
| A | 6.40 | 6.6 | 6.80 |
| B | 5.2 | 5.35 | 5.50 |
| C | 9.40 | 9.80 | 10.20 |
| D | 2.40 | 2.70 | 3.00 |
| P | 1.27 REF. | | |
| S | 0.50 | 0.65 | 0.80 |
| E3 | 3.50 | 4.00 | 4.50 |
| R | 0.80 | 1.00 | 1.20 |
| G | 0.40 | 0.50 | 0.60 |
| H | 2.20 | 2.30 | 2.40 |
| J | 0.45 | 0.50 | 0.55 |
| K | 0.00 | 0.075 | 0.15 |
| L | 0.90 | 1.20 | 1.50 |
| M | 5.40 | 5.60 | 5.80 |



1. All dimensions are in millimeters.
2. Dimensions do not include mold protrusions.

Marking Information:



Product: AP4525

Package:

GEH = RoHS-compliant halogen-free TO-252-4L

Date/lot code (YWWSSS)

Y: Last digit of the year

WW: Work week

SSS: Lot code sequence

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